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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



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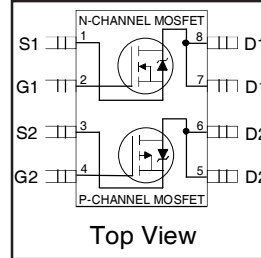
PD - 96115B

International  
**IR** Rectifier

**IRF9952QPbF**

HEXFET® Power MOSFET

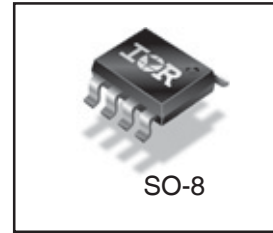
- Advanced Process Technology
- Ultra Low On-Resistance
- Dual N and P Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- 150°C Operating Temperature
- Lead-Free



	N-Ch	P-Ch
$V_{DS}$	30V	-30V
$R_{DS(on)}$	0.10Ω	0.25Ω

**Description**

These HEXFET® Power MOSFET's in a Dual SO-8 package utilize the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of these HEXFET Power MOSFET's are a 150°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These benefits combine to make this design an extremely efficient and reliable device for use in a wide variety of applications. The efficient SO-8 package provides enhanced thermal characteristics and dual MOSFET die capability making it ideal in a variety of power applications. This dual, surface mount SO-8 can dramatically reduce board space and is also available in Tape & Reel.



Base part number	Orderable part number	Package Type	Standard Pack		EOL Notice	Replacement Part Number
			Form	Quantity		
IRF9952QPbF	IRF9952QTRPbF	SO-8	Tape and Reel	4000	EOL 529	<a href="#">Please search the EOL part number on IR's website for guidance</a>
	IRF9952QPbF	SO-8	Tube	95	EOL 529	

	Symbol	Maximum		Units	
		N-Channel	P-Channel		
Drain-Source Voltage	$V_{DS}$	30		V	
Gate-Source Voltage	$V_{GS}$	± 20			
Continuous Drain Current <sup>⑤</sup>	$I_D$	$T_A = 25^\circ\text{C}$	3.5	-2.3	A
		$T_A = 70^\circ\text{C}$	2.8	-1.8	
Pulsed Drain Current	$I_{DM}$	16	-10		
Continuous Source Current (Diode Conduction)	$I_S$	1.7	-1.3		
Maximum Power Dissipation <sup>⑤</sup>	$P_D$	$T_A = 25^\circ\text{C}$	2.0		W
		$T_A = 70^\circ\text{C}$	1.3		
Single Pulse Avalanche Energy	$E_{AS}$	44	57	mJ	
Avalanche Current	$I_{AR}$	2.0	-1.3	A	
Repetitive Avalanche Energy	$E_{AR}$	0.25		mJ	
Peak Diode Recovery dv/dt <sup>②</sup>	dv/dt	5.0	-5.0	V/ ns	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to + 150		°C	

**Thermal Resistance Ratings**

Parameter	Symbol	Limit	Units
Maximum Junction-to-Ambient <sup>⑤</sup>	$R_{\theta JA}$	62.5	°C/W

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## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

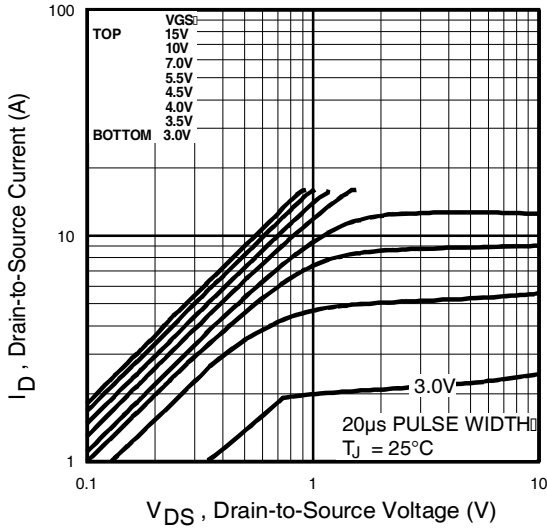
Parameter	Min.	Typ.	Max.	Units	Conditions	
						Parameter
V <sub>(BR)DSS</sub>	N-Ch 30 P-Ch -30	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	
ΔV <sub>(BR)DSS</sub> /ΔT <sub>J</sub>	N-Ch — P-Ch —	0.015	—		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA Reference to 25°C, I <sub>D</sub> = -1mA
R <sub>DS(ON)</sub>	N-Ch — P-Ch —	0.08 0.12	0.10 0.15	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 2.2A ④ V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 1.0A ④ V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.0A ④ V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.50A ④	
V <sub>GS(th)</sub>	N-Ch 1.0 P-Ch -1.0	—	—		V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA
g <sub>fs</sub>	N-Ch — P-Ch —	12	—		S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 3.5A ④ V <sub>DS</sub> = -15V, I <sub>D</sub> = -2.3A ④
I <sub>DSS</sub>	N-Ch — P-Ch —	—	2.0 -2.0		μA	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V V <sub>DS</sub> = -24V, V <sub>GS</sub> = 0V
I <sub>GSS</sub>	N-P —	—	±100	nA	V <sub>GS</sub> = ±20V	
Q <sub>g</sub>	N-Ch — P-Ch —	6.9	14	nC	N-Channel I <sub>D</sub> = 1.8A, V <sub>DS</sub> = 10V, V <sub>GS</sub> = 10V ④	
Q <sub>gs</sub>	N-Ch — P-Ch —	1.0	2.0		P-Channel I <sub>D</sub> = -2.3A, V <sub>DS</sub> = -10V, V <sub>GS</sub> = -10V	
Q <sub>gd</sub>	N-Ch — P-Ch —	1.8	3.5			
t <sub>d(on)</sub>	N-Ch — P-Ch —	6.2	12		N-Channel V <sub>DD</sub> = 10V, I <sub>D</sub> = 1.0A, R <sub>G</sub> = 6.0Ω, R <sub>D</sub> = 10Ω ④	
t <sub>r</sub>	N-Ch — P-Ch —	8.8	18	ns		
t <sub>d(off)</sub>	N-Ch — P-Ch —	13	26		P-Channel V <sub>DD</sub> = -10V, I <sub>D</sub> = -1.0A, R <sub>G</sub> = 6.0Ω, R <sub>D</sub> = 10Ω ④	
t <sub>f</sub>	N-Ch — P-Ch —	3.0	6.0			
C <sub>iss</sub>	N-Ch — P-Ch —	190	—		pF	N-Channel V <sub>GS</sub> = 0V, V <sub>DS</sub> = 15V, f = 1.0MHz
C <sub>oss</sub>	N-Ch — P-Ch —	120	—	pF	P-Channel V <sub>GS</sub> = 0V, V <sub>DS</sub> = -15V, f = 1.0MHz	
C <sub>rss</sub>	N-Ch — P-Ch —	61	—			

## Source-Drain Ratings and Characteristics

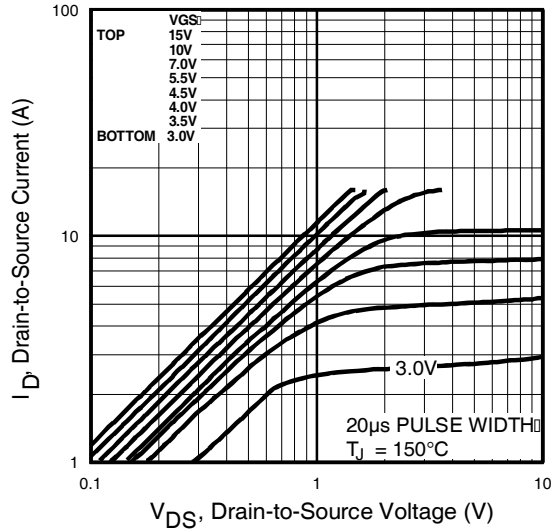
Parameter	Min.	Typ.	Max.	Units	Conditions
I <sub>S</sub>	N-Ch — P-Ch —	—	1.7 -1.3	A	
I <sub>SM</sub>	N-Ch — P-Ch —	—	16 16		
V <sub>SD</sub>	N-Ch — P-Ch —	0.82 -0.82	1.2 -1.2	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = 1.25A, V <sub>GS</sub> = 0V ③ T <sub>J</sub> = 25°C, I <sub>S</sub> = -1.25A, V <sub>GS</sub> = 0V ③
t <sub>rr</sub>	N-Ch — P-Ch —	27	53 54	ns	N-Channel T <sub>J</sub> = 25°C, I <sub>F</sub> = 1.25A, di/dt = 100A/μs ④
Q <sub>rr</sub>	N-Ch — P-Ch —	28	57 62	nC	P-Channel T <sub>J</sub> = 25°C, I <sub>F</sub> = -1.25A, di/dt = 100A/μs ④

### Notes:

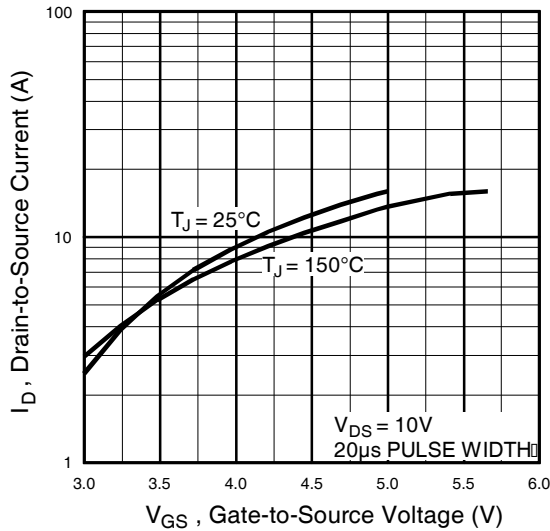
- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 23 )
- ② N-Channel I<sub>SD</sub> ≤ 2.0A, di/dt ≤ 100A/μs, V<sub>DD</sub> ≤ V<sub>(BR)DSS</sub>, T<sub>J</sub> ≤ 150°C  
P-Channel I<sub>SD</sub> ≤ -1.3A, di/dt ≤ 84A/μs, V<sub>DD</sub> ≤ V<sub>(BR)DSS</sub>, T<sub>J</sub> ≤ 150°C
- ③ N-Channel Starting T<sub>J</sub> = 25°C, L = 22mH R<sub>G</sub> = 25Ω, I<sub>AS</sub> = 2.0A. (See Figure 12)  
P-Channel Starting T<sub>J</sub> = 25°C, L = 67mH R<sub>G</sub> = 25Ω, I<sub>AS</sub> = -1.3A.
- ④ Pulse width ≤ 300μs; duty cycle ≤ 2%.
- ⑤ Surface mounted on FR-4 board, t ≤ 10sec.



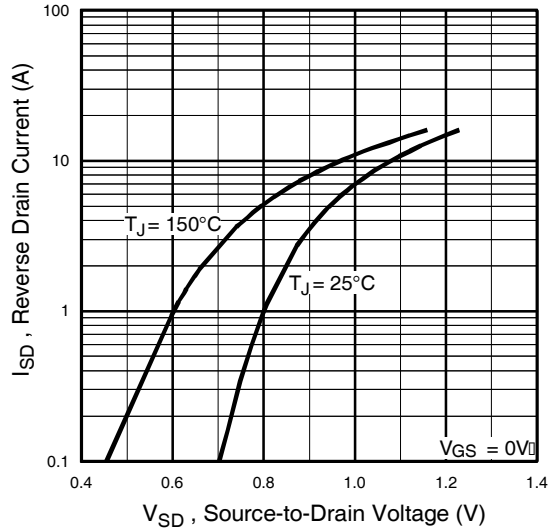
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



**Fig 3.** Typical Transfer Characteristics



**Fig 4.** Typical Source-Drain Diode Forward Voltage

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N-Channel

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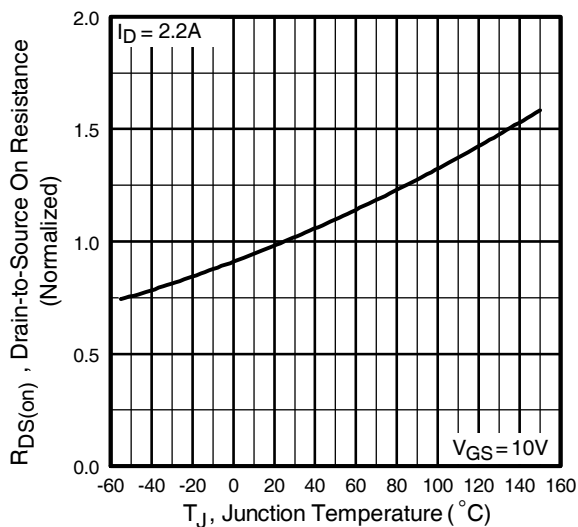


Fig 5. Normalized On-Resistance Vs. Temperature

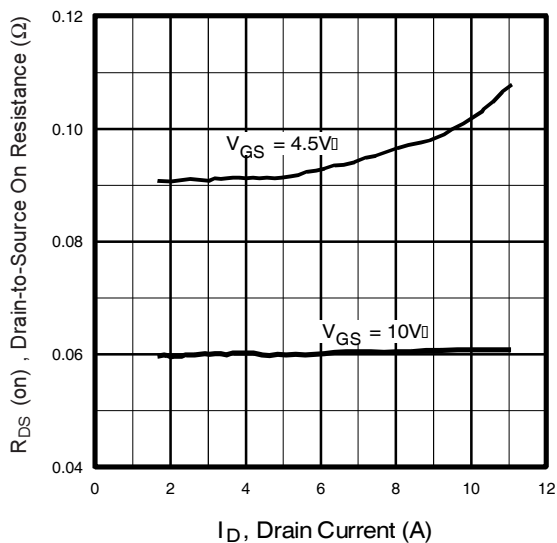


Fig 6. Typical On-Resistance Vs. Drain Current

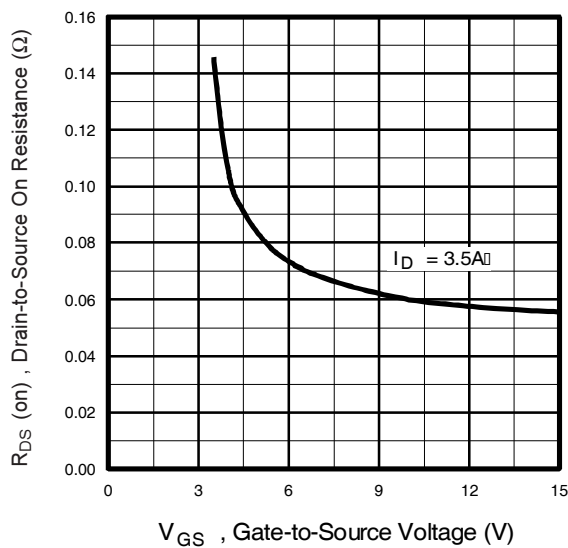


Fig 7. Typical On-Resistance Vs. Gate Voltage

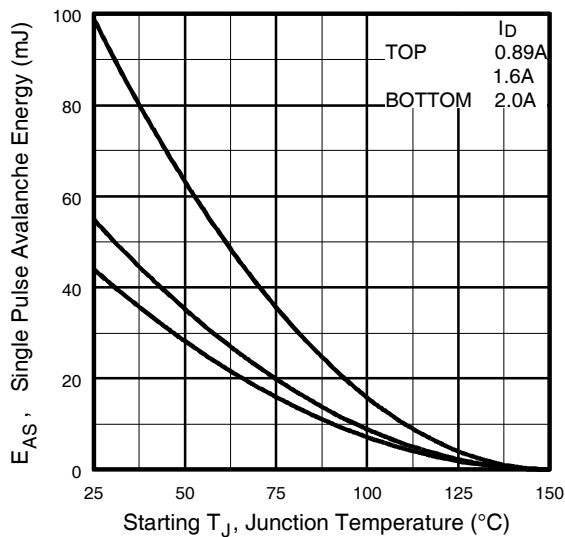


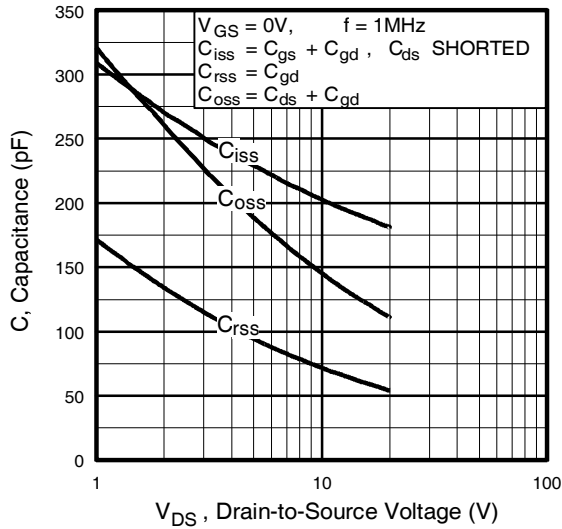
Fig 8. Maximum Avalanche Energy Vs. Drain Current

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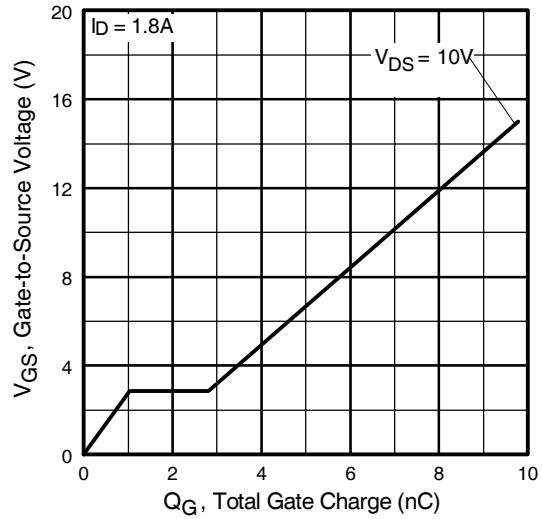
International  
**IR** Rectifier

N-Channel

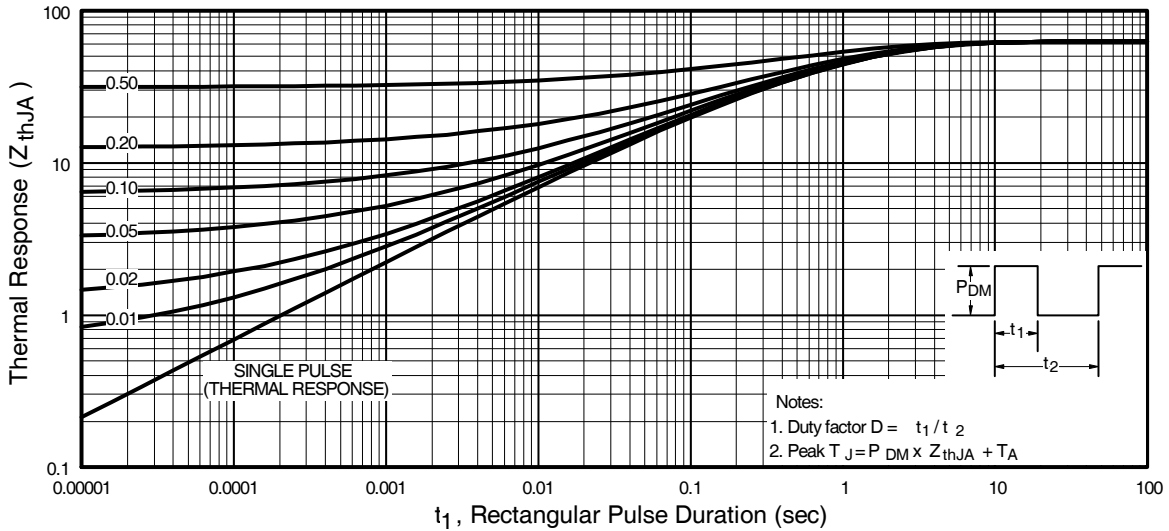
**IRF9952QPbF**



**Fig 9.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 10.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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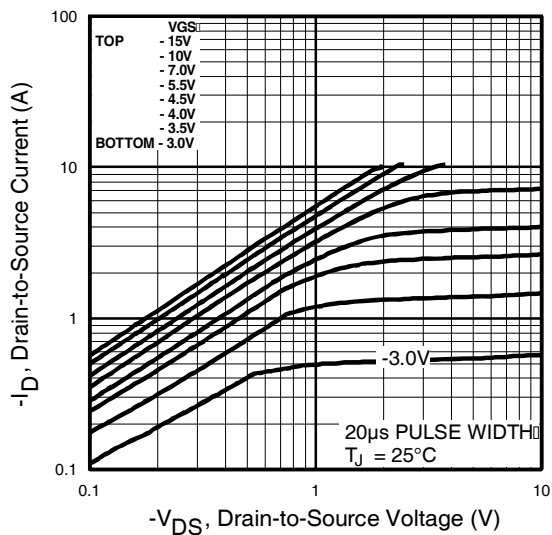


Fig 12. Typical Output Characteristics

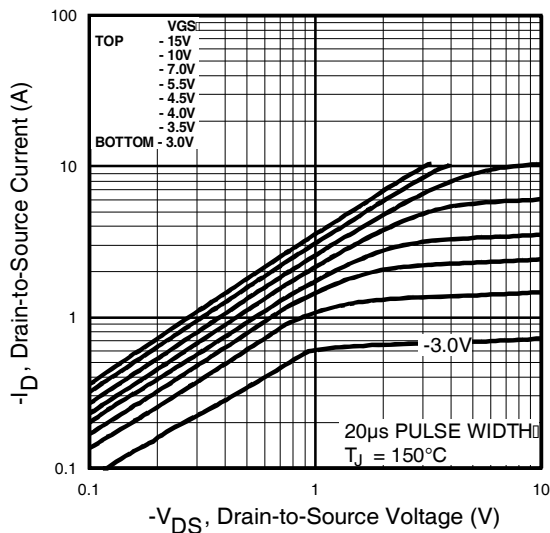


Fig 13. Typical Output Characteristics

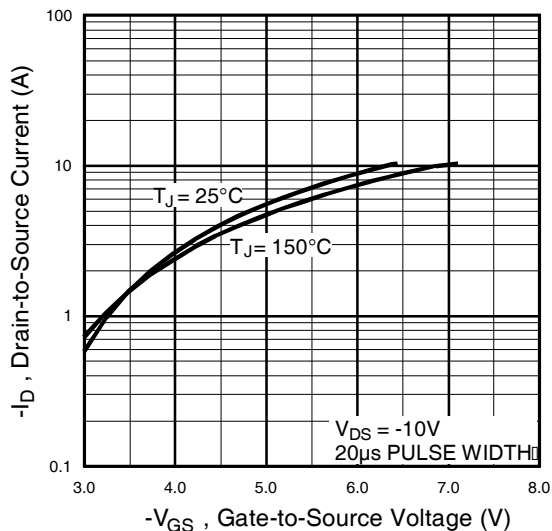


Fig 14. Typical Transfer Characteristics

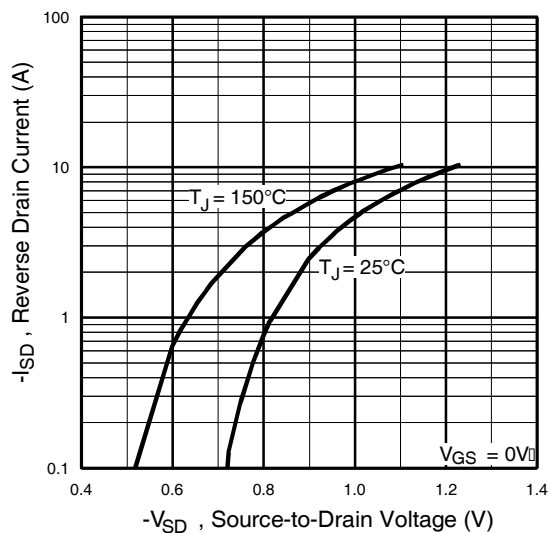
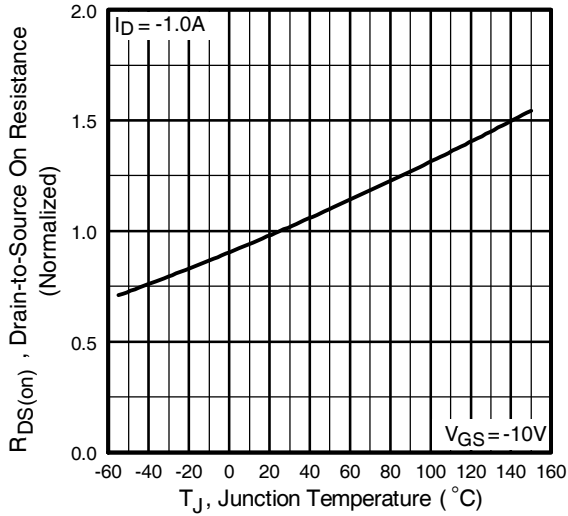
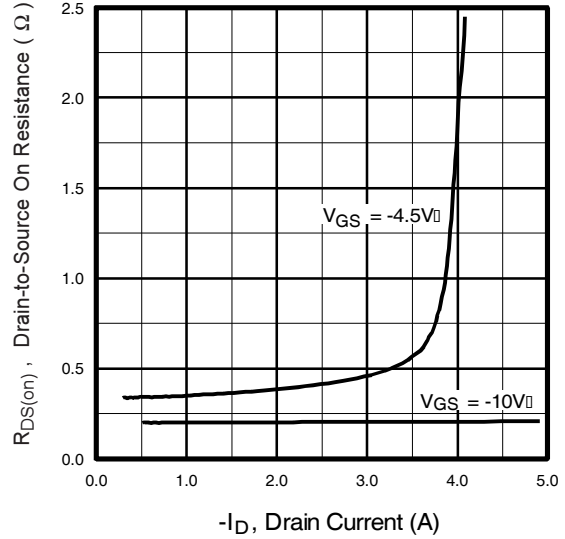


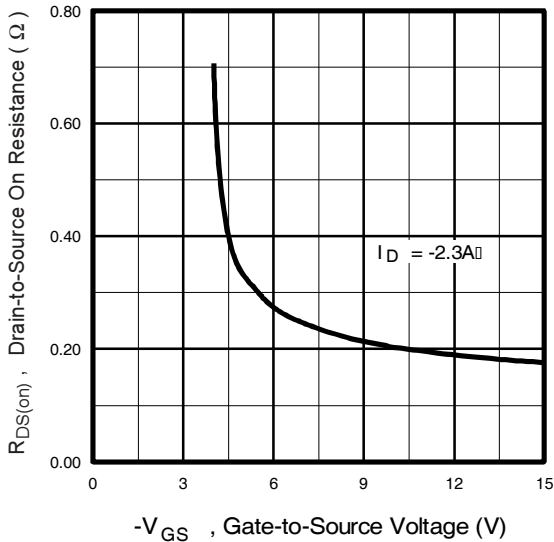
Fig 15. Typical Source-Drain Diode Forward Voltage



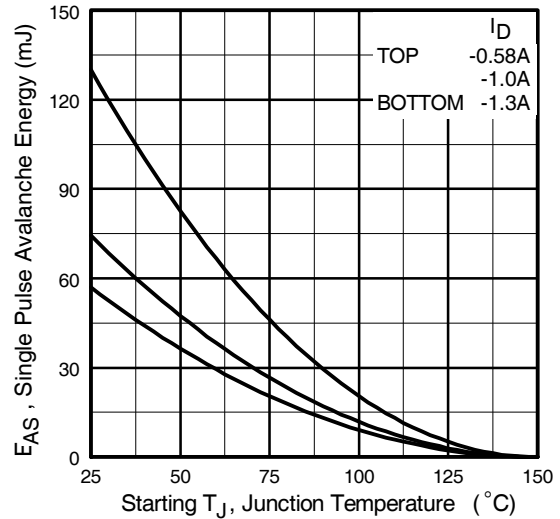
**Fig 16.** Normalized On-Resistance Vs. Temperature



**Fig 17.** Typical On-Resistance Vs. Drain Current



**Fig 18.** Typical On-Resistance Vs. Gate Voltage



**Fig 19.** Maximum Avalanche Energy Vs. Drain Current

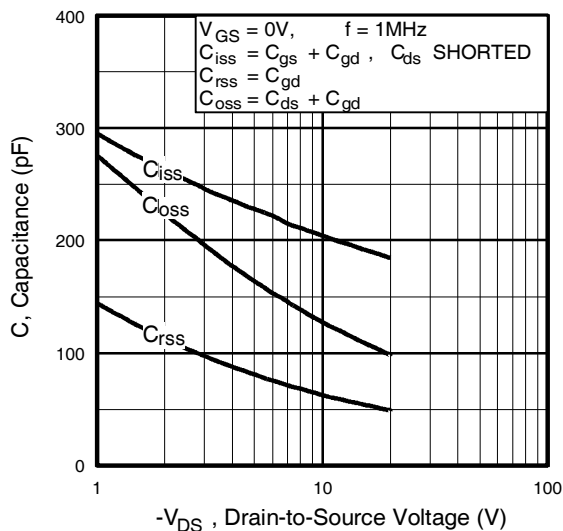


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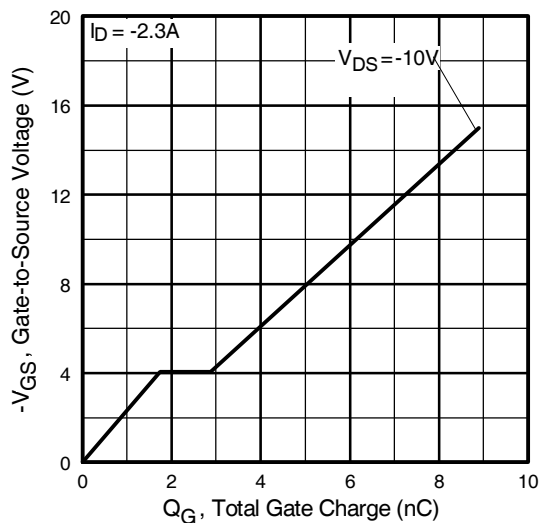
**IRF9952QPbF**

P-Channel

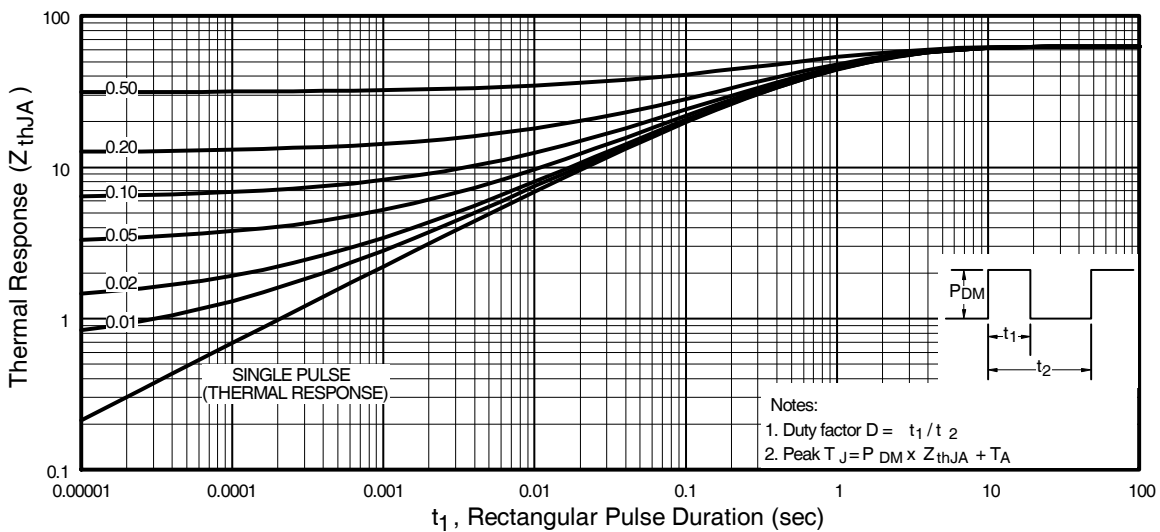
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**Fig 20.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 21.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 22.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

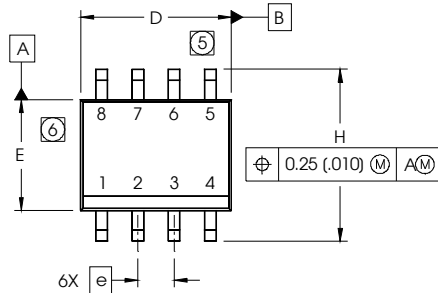
**END OF LIFE**

International  
**IR** Rectifier

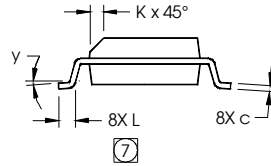
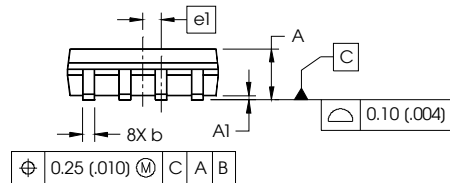
**IRF9952QPbF**

**SO-8 Package Outline**

Dimensions are shown in millimeters (inches)



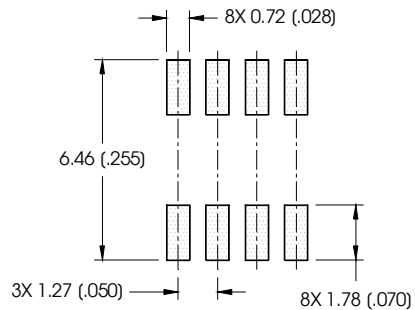
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°



**NOTES:**

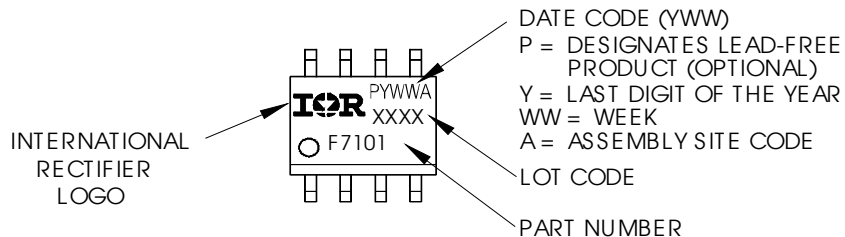
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- ⑤ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- ⑥ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- ⑦ DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

**FOOTPRINT**



**SO-8 Part Marking**

EXAMPLE: THIS IS AN IRF7101 (MOSFET)



**Notes:**

1. For an Automotive Qualified version of this part please see: <http://www.irf.com/product-info/autos>
2. For the most current drawing please refer to IR website at <http://www.irf.com/package/>

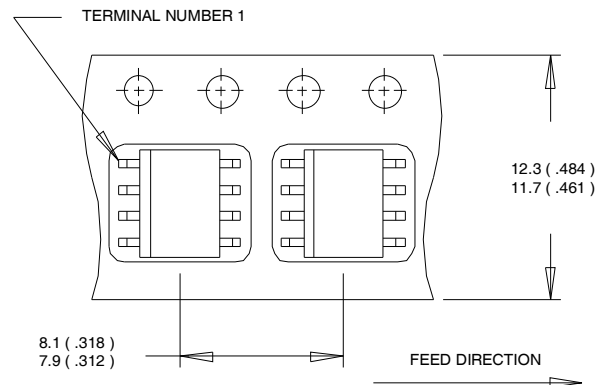
**END OF LIFE**

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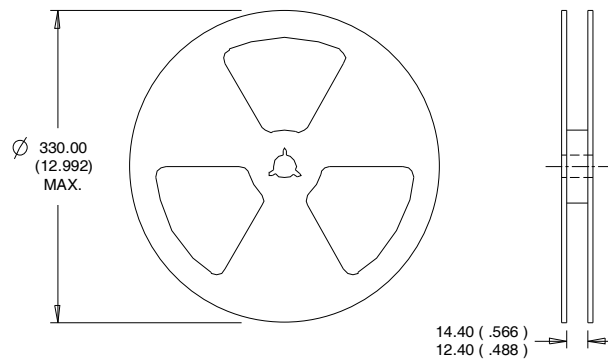
## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



**NOTES:**

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



**NOTES :**

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

For the most current drawing please refer to IR website at <http://www.irf.com/package/>

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**Qualification Information<sup>†</sup>**

Qualification level	Industrial <sup>†</sup>	
	(per JEDEC JESD47F <sup>††</sup> guidelines)	
Moisture Sensitivity Level	SO-8	MSL1 (per JEDEC J-STD-020D <sup>††</sup> )
RoHS Compliant	Yes	

† Qualification standards can be found at International Rectifier's web site  
<http://www.irf.com/product-info/reliability>

†† Applicable version of JEDEC standard at the time of product release.

**Revision History**

Date	Comments
10/3/2014	• Added ordering information to reflect the End-Of-life